

# APPROVAL

| PART NO.         | DESCRIPTION              | REMARKS                         |
|------------------|--------------------------|---------------------------------|
| <b>HO6448B01</b> | <b>OLED</b><br>(64 × 48) | <b>* This is ROHS compliant</b> |

|                          |  |
|--------------------------|--|
| CUSTOMER APPLICATION P/N |  |
| APPROVED BY              |  |
| DATE                     |  |

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HEREIN AND RETURN ONE COPY HERE OF WITH YOUR SIGNATURE OF APPROVAL.

|             |            |              |
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|             |            |              |



**HYES Optoelectronics, Inc.**

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## 1. Basic Specifications

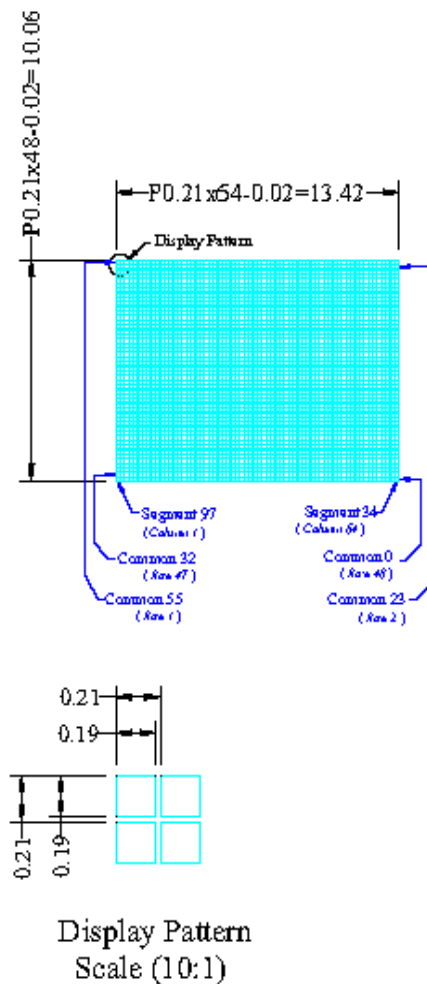
### 1.1 Display Specifications

- 1) Display Mode: Passive Matrix
- 2) Display Color: Monochrome (Light Blue)
- 3) Drive Duty: 1/48 Duty

### 1.2 Mechanical Specifications

- 1) Outline Drawing: According to the annexed outline drawing number
- 2) Number of Pixels:  $64 \times 48$
- 3) Panel Size:  $18.46 \times 18.10 \times 2.10$  (mm)
- 4) Active Area:  $13.42 \times 10.06$  (mm)
- 5) Pixel Pitch:  $0.21 \times 0.21$  (mm)
- 6) Pixel Size:  $0.19 \times 0.19$  (mm)
- 7) Weight: 1.3 (g)

### 1.3 Active Area & Pixel Construction



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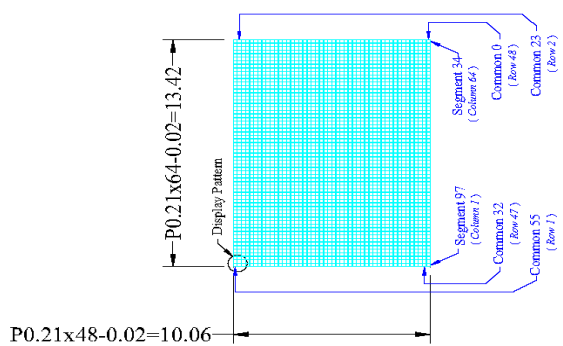
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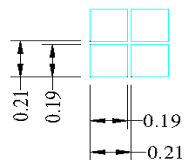
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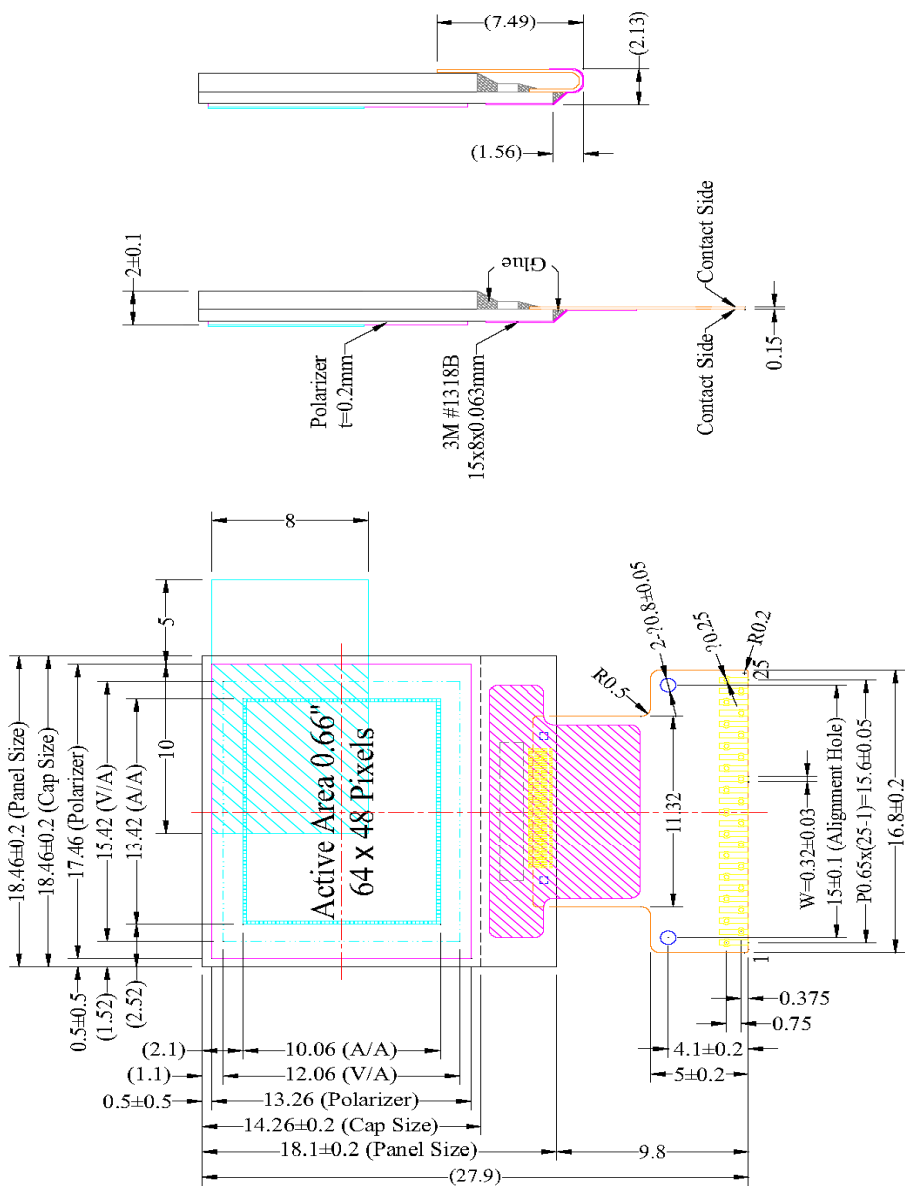
## L4 Mechanical Drawing



| Pin | Symbol |
|-----|--------|
| 1   | NC     |
| 2   | VCC    |
| 3   | VSS    |
| 4   | VDD    |
| 5   | VDDIO  |
| 6   | BS1    |
| 7   | BS2    |
| 8   | CS     |
| 9   | RES    |
| 10  | D/C    |
| 11  | WR     |
| 12  | RD     |
| 13  | D0     |
| 14  | D1     |
| 15  | D2     |
| 16  | D3     |
| 17  | D4     |
| 18  | D5     |
| 19  | D6     |
| 20  | D7     |
| 21  | IREF   |
| 22  | VCOMH  |
| 23  | VCC    |
| 24  | VSS    |
| 25  | NC     |



Display Pattern  
Scale (10:1)



Notes:

1. OLED Color: Blue
2. Driver IC: SSD1305Z
3. FPC Number: UT-0205-P02
4. Interface:
  - 8-bit (68XX/80XX Parallel, 4-SPI, I2C)
  5. General Tolerance:  $\pm 0.30$
  6. The total thickness (2.10 Max) is without the assembled total thickness with the

The actual assembled total thickness with above materials should be 2.25 Max.

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## 1.5 Pin Definition

| Pin Number                                                                          | Symbol           | Type          | Function                                                                                                                                                                                                                                                                                                                                              |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
|-------------------------------------------------------------------------------------|------------------|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|------------------|---------------|---------------|--------|-----|---|---|---|---|-----|---|---|---|---|
| Power Supply Pins                                                                   |                  |               |                                                                                                                                                                                                                                                                                                                                                       |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 4                                                                                   | VDD              | P             | Power Supply for Core Logic Operation<br>This is a voltage supply pin. It must be connected to external source.                                                                                                                                                                                                                                       |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 5                                                                                   | VDDIO            | P             | Power Supply for Interface Logic Level<br>This is a voltage supply pin. It should be match with MCU interface voltage level. VDDIO must always be equal or lower than VDD.                                                                                                                                                                            |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 3, 24                                                                               | VSS              | P             | Ground of OEL System<br>This is a ground pin. It also acts as a reference for the logic pins, the OEL driving voltages, and the analog circuits. It must be connected to external ground.                                                                                                                                                             |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 2, 23                                                                               | VCC              | P             | Power Supply for OEL Panel<br>This is the most positive voltage supply pin of the chip. It must be connected to external source.                                                                                                                                                                                                                      |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| System Control Pins                                                                 |                  |               |                                                                                                                                                                                                                                                                                                                                                       |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 21                                                                                  | IREF             | I             | Current Reference for Brightness Adjustment<br>This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current at 10uA.                                                                                                                                                                           |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 22                                                                                  | VCOMH            | O             | Voltage Output High Level for COM Signal<br>This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.                                                                                                                                                                    |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 6<br>7                                                                              | BS1<br>BS2       | I             | Communicating Protocol Select<br>These pins are MCU interface selection input. See the following table: <table><tr><td></td><td>I<sup>2</sup>C</td><td>6800-parallel</td><td>8080-parallel</td><td>Serial</td></tr><tr><td>BS1</td><td>1</td><td>0</td><td>1</td><td>0</td></tr><tr><td>BS2</td><td>0</td><td>1</td><td>1</td><td>0</td></tr></table> |        | I <sup>2</sup> C | 6800-parallel | 8080-parallel | Serial | BS1 | 1 | 0 | 1 | 0 | BS2 | 0 | 1 | 1 | 0 |
|                                                                                     | I <sup>2</sup> C | 6800-parallel | 8080-parallel                                                                                                                                                                                                                                                                                                                                         | Serial |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| BS1                                                                                 | 1                | 0             | 1                                                                                                                                                                                                                                                                                                                                                     | 0      |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| BS2                                                                                 | 0                | 1             | 1                                                                                                                                                                                                                                                                                                                                                     | 0      |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| Note: "0" is connected to V <sub>SS</sub> ; "1" is connected to V <sub>DDIO</sub> . |                  |               |                                                                                                                                                                                                                                                                                                                                                       |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| MPU Interface Pins                                                                  |                  |               |                                                                                                                                                                                                                                                                                                                                                       |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 8                                                                                   | CS               | I             | Chip Select<br>This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.                                                                                                                                                                                                                              |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 9                                                                                   | RES              | I             | Power Reset for Controller and Driver<br>This pin is reset signal input. When the pin is low, initialization of the chip is executed.                                                                                                                                                                                                                 |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |
| 10                                                                                  | D/C              | I             | Data/Command Control<br>This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams.          |        |                  |               |               |        |     |   |   |   |   |     |   |   |   |   |

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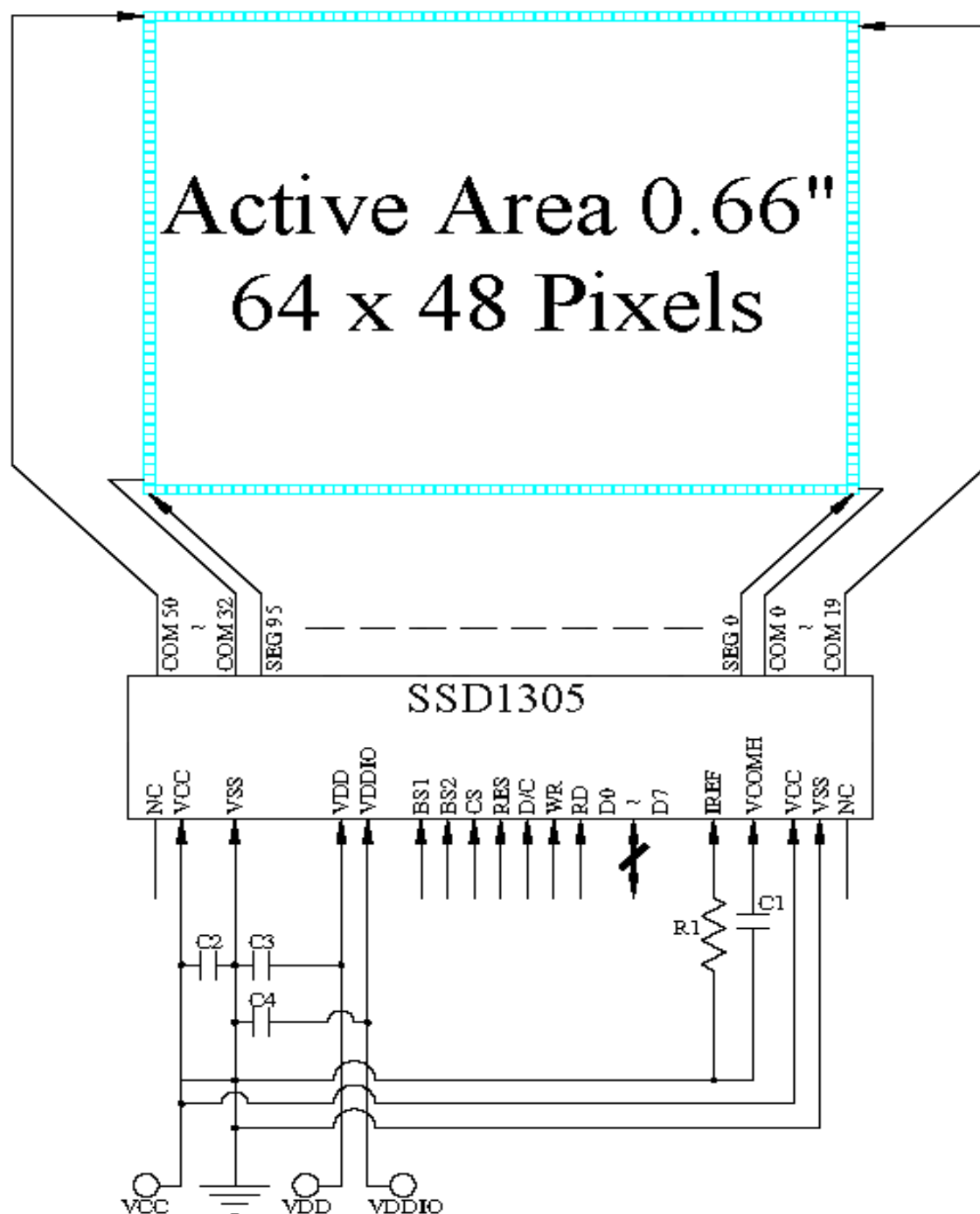
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## 1.5 Pin Definition (Continued)

| Pin Number                            | Symbol | Type | Function                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|---------------------------------------|--------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <i>MPU Interface Pins (Continued)</i> |        |      |                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 11                                    | WR     | I    | <p><i>Read/Write Select or Write</i></p> <p>This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode.</p> <p>When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.</p>    |
| 12                                    | RD     | I    | <p><i>Read/Write Enable or Read</i></p> <p>This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low.</p> <p>When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.</p> |
| 13~20                                 | D0~D7  | I/O  | <p><i>Host Data Input/Output Bus</i></p> <p>These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK.</p>                                                                                                                                                                                             |
| <i>Reserved Pins</i>                  |        |      |                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 1, 25                                 | NC     | -    | <i>No Connection</i>                                                                                                                                                                                                                                                                                                                                                                                                                                       |

## 1.6 Block Diagram



MCU Interface Selection: BS1 and BS2

Pins connected to MCU interface: D7~D0, RD, WR, D/C, RES, and CS

C1, C2, C3, C4: 4.7 $\mu$ F

R1: 910k $\Omega$ ,  $R1 = (\text{Voltage at IREF} - V_{SS}) / I_{REF}$

## 2. Absolute Maximum Ratings

| Parameter                   | Symbol     | Min  | Max          | Unit | Notes |
|-----------------------------|------------|------|--------------|------|-------|
| Supply Voltage              | $V_{DD}$   | -0.3 | 4            | V    | 1, 2  |
| Supply Voltage for I/O Pins | $V_{DDIO}$ | -0.3 | $V_{DD}+0.5$ | V    | 1, 2  |
| Driver Supply Voltage       | $V_{CC}$   | 0    | 15           | V    | 1, 2  |
| Operating Temperature       | $T_{OP}$   | -30  | 70           | °C   | -     |
| Storage Temperature         | $T_{STG}$  | -40  | 80           | °C   | -     |

Note 1: All the above voltages are on the basis of "GND = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

## 3. Electrical Characteristics

### 3.1 DC Characteristics

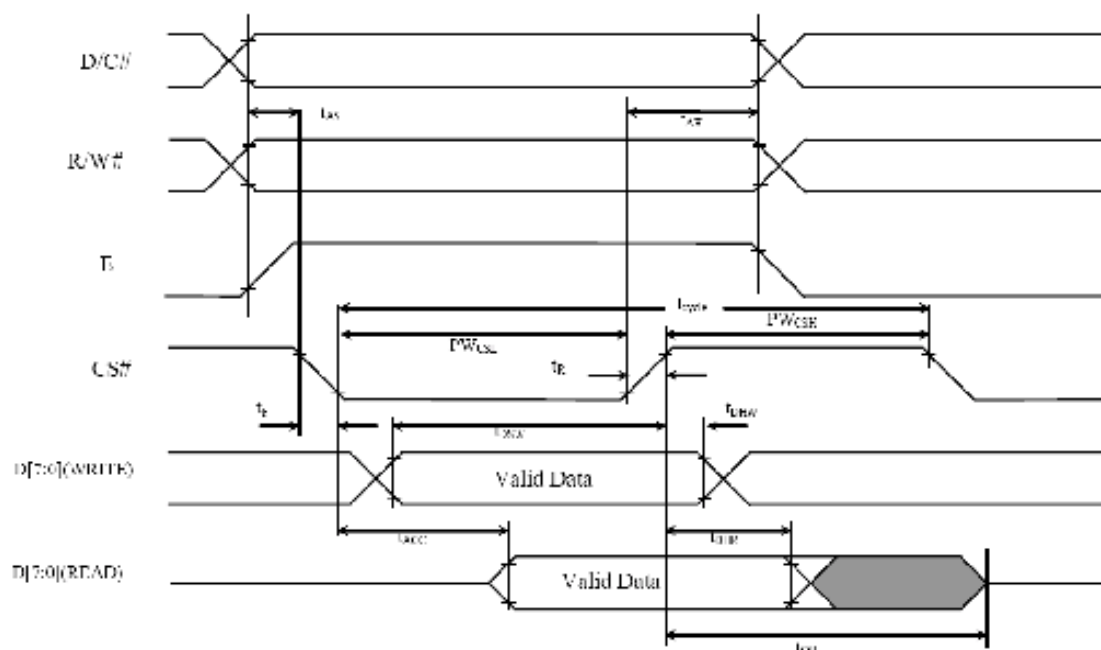
| Characteristics             | Symbol     | Conditions                    | Min                 | Typ | Max                 | Unit |
|-----------------------------|------------|-------------------------------|---------------------|-----|---------------------|------|
| Supply Voltage              | $V_{DD}$   | -                             | 2.6                 | 2.8 | 3.5                 | V    |
| Supply Voltage for I/O Pins | $V_{DDIO}$ | -                             | 1.6                 | 2.8 | $V_{DD}$            | V    |
| Driver Supply Voltage       | $V_{CC}$   | -                             | 8.5                 | 9   | 9.5                 | V    |
| High Level Input            | $V_{IH}$   | -                             | $0.8 \times V_{DD}$ | -   | $V_{DD}$            | V    |
| Low Level Input             | $V_{IL}$   | -                             | 0                   | -   | $0.2 \times V_{DD}$ | V    |
| High Level Output           | $V_{OH}$   | $I_{out} = 100 \mu A, 3.3MHz$ | $0.9 \times V_{DD}$ | -   | $V_{DD}$            | V    |
| Low Level Output            | $V_{OL}$   | $I_{out} = 100 \mu A, 3.3MHz$ | 0                   | -   | $0.1 \times V_{DD}$ | V    |

## 3.2 AC Characteristics

### 3.2.1 6800-Series MPU Parallel Interface Timing Characteristics:

| Symbol             | Description                          | Min | Max | Unit |
|--------------------|--------------------------------------|-----|-----|------|
| $t_{\text{cycle}}$ | System Cycle Time                    | 300 | -   | ns   |
| $t_{\text{AS}}$    | Address Setup Time                   | 0   | -   | ns   |
| $t_{\text{AH}}$    | Address Hold Time                    | 0   | -   | ns   |
| $t_{\text{DSW}}$   | Write Data Setup Time                | 40  | -   | ns   |
| $t_{\text{DHW}}$   | Write Data Hold Time                 | 7   | -   | ns   |
| $t_{\text{DHR}}$   | Read Data Hold Time                  | 20  | -   | ns   |
| $t_{\text{OH}}$    | Output Disable Time                  | -   | 70  | ns   |
| $t_{\text{ACC}}$   | Access Time                          | -   | 140 | ns   |
| $PW_{\text{CSL}}$  | Chip Select Low Pulse Width (Read)   | 120 | -   | ns   |
|                    | Chip Select Low pulse width (Write)  | 60  | -   | ns   |
| $PW_{\text{CSH}}$  | Chip Select High Pulse Width (Read)  | 60  | -   | ns   |
|                    | Chip Select High Pulse Width (Write) | 60  | -   | ns   |
| $t_{\text{R}}$     | Rise Time                            | -   | 15  | ns   |
| $t_{\text{F}}$     | Fall Time                            | -   | 15  | ns   |

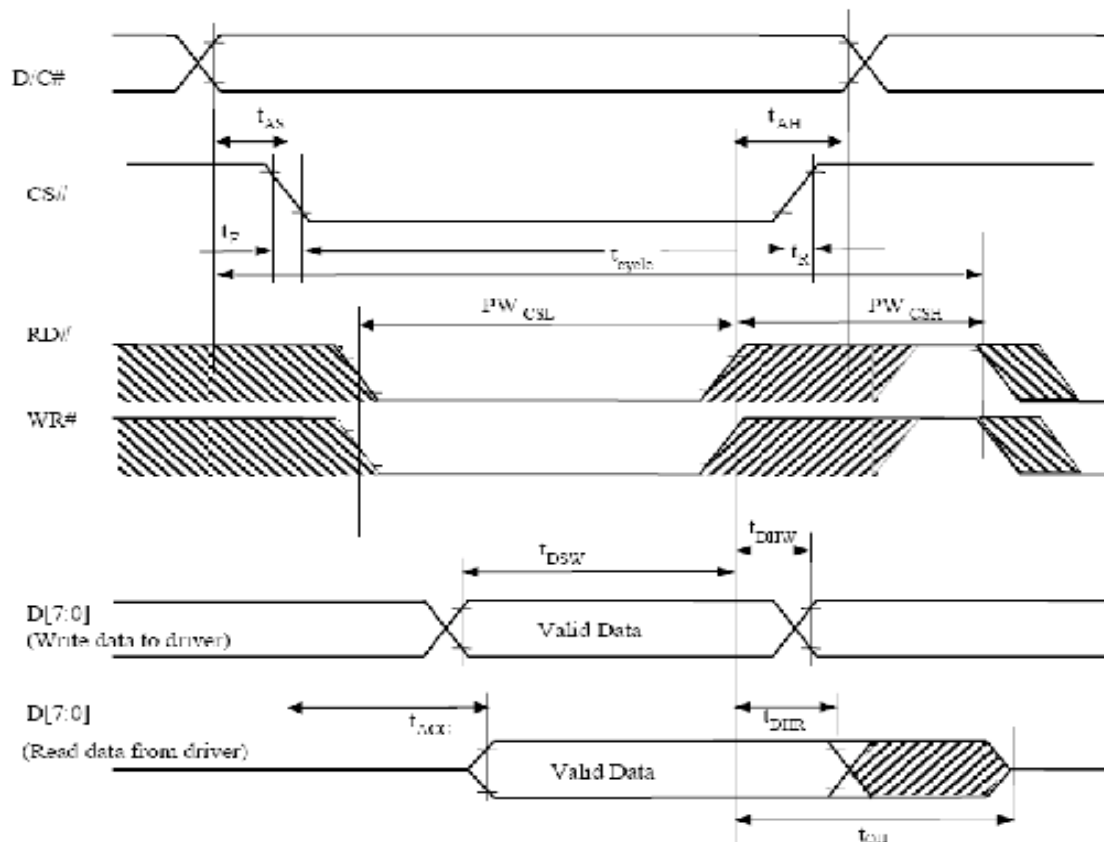
\*  $V_{\text{DD}} \sim V_{\text{SS}} = 2.4$  to  $3.5\text{V}$ ,  $T_{\text{A}} = 25^{\circ}\text{C}$



### 3.2.2 8080-Series MPU Parallel Interface Timing Characteristics:

| Symbol             | Description                          | Min | Max | Unit |
|--------------------|--------------------------------------|-----|-----|------|
| $t_{\text{cycle}}$ | System Cycle Time                    | 300 | -   | ns   |
| $t_{\text{AS}}$    | Address Setup Time                   | 0   | -   | ns   |
| $t_{\text{AH}}$    | Address Hold Time                    | 0   | -   | ns   |
| $t_{\text{DSW}}$   | Write Data Setup Time                | 40  | -   | ns   |
| $t_{\text{DHW}}$   | Write Data Hold Time                 | 7   | -   | ns   |
| $t_{\text{DHR}}$   | Read Data Hold Time                  | 20  | -   | ns   |
| $t_{\text{OH}}$    | Output Disable Time                  | -   | 70  | ns   |
| $t_{\text{ACC}}$   | Access Time                          | -   | 140 | ns   |
| $PW_{\text{CSL}}$  | Chip Select Low Pulse Width (Read)   | 120 | -   | ns   |
|                    | Chip Select Low pulse width (Write)  | 60  | -   | ns   |
| $PW_{\text{CSH}}$  | Chip Select High Pulse Width (Read)  | 60  | -   | ns   |
|                    | Chip Select High Pulse Width (Write) | 60  | -   | ns   |
| $t_{\text{R}}$     | Rise Time                            | -   | 15  | ns   |
| $t_{\text{F}}$     | Fall Time                            | -   | 15  | ns   |

\*  $V_{\text{DD}} \sim V_{\text{SS}} = 2.4$  to  $3.5\text{V}$ ,  $T_{\text{A}} = 25^{\circ}\text{C}$



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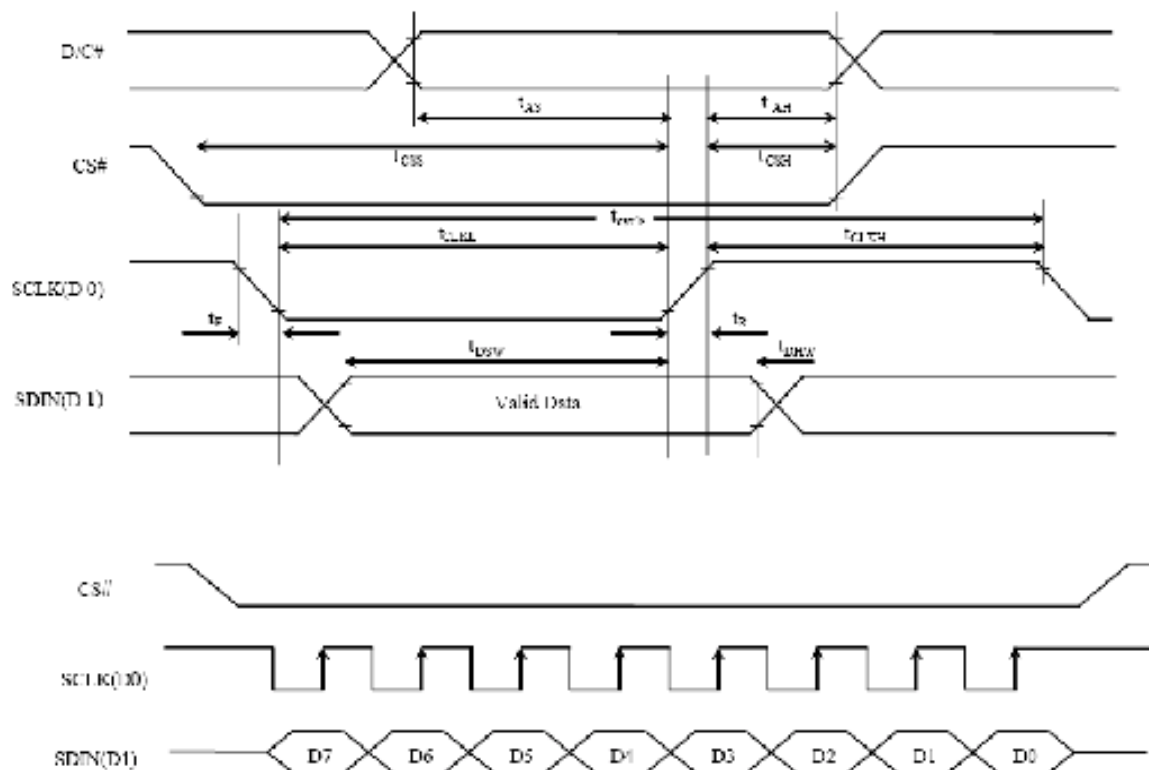
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### 3.2.3 Serial Interface Timing Characteristics:

| Symbol             | Description            | Min | Max | Unit |
|--------------------|------------------------|-----|-----|------|
| $t_{\text{cycle}}$ | Clock Cycle Time       | 250 | -   | ns   |
| $t_{\text{AS}}$    | Address Setup Time     | 150 | -   | ns   |
| $t_{\text{AH}}$    | Address Hold Time      | 150 | -   | ns   |
| $t_{\text{CSS}}$   | Chip Select Setup Time | 120 | -   | ns   |
| $t_{\text{CSH}}$   | Chip Select Hold Time  | 60  | -   | ns   |
| $t_{\text{DSW}}$   | Write Data Setup Time  | 50  | -   | ns   |
| $t_{\text{DHW}}$   | Write Data Hold Time   | 15  | -   | ns   |
| $t_{\text{CLKH}}$  | Serial Clock High Time | 100 | -   | ns   |
| $t_{\text{CLKL}}$  | Serial Clock Low Time  | 100 | -   | ns   |
| $t_{\text{R}}$     | Rise Time              | -   | 15  | ns   |
| $t_{\text{F}}$     | Fall Time              | -   | 15  | ns   |

\*  $V_{\text{DD}} \sim V_{\text{SS}} = 2.4$  to  $3.5\text{V}$ ,  $T_{\text{A}} = 25^{\circ}\text{C}$



### 3.3 Optics & Electrical Characteristics

| Characteristics    | Symbol   | Conditions        | Min  | Typ    | Max  | Unit     |
|--------------------|----------|-------------------|------|--------|------|----------|
| Brightness         | $L_{br}$ | With Polarizer    | 40   | 60     | -    | $cd/m^2$ |
| C.I.E. (Blue)      | (x)      | Without Polarizer | 0.12 | 0.16   | 0.20 |          |
|                    | (y)      |                   | 0.24 | 0.28   | 0.30 |          |
| Dark Room Contrast | CR       |                   | -    | >100:1 | -    |          |
| View Angle         |          |                   | >160 | -      | -    | degree   |

Note 3: Optical measurement taken at 1/48 duty, 190Hz Frame Rate, 0x2D Contrast Setting.

### 3.4 General Electrical Specification

| Characteristics                              | Symbol                | Conditions | Min | Typ | Max      | Unit    |
|----------------------------------------------|-----------------------|------------|-----|-----|----------|---------|
| Supply Voltage                               | $V_{DD}$              | -          | 2.6 | 2.8 | 3.5      | V       |
| Supply Voltage for I/O Pins                  | $V_{DDIO}$            | -          | 1.6 | 2.8 | $V_{DD}$ | V       |
| Driver Supply Voltage                        | $V_{CC}$              | -          | 8.5 | 9   | 9.5      | V       |
| Operating Current for $V_{DD}$ & $V_{DDIO}$  | $I_{DD\&DDIO}$        | Note 4     | -   | 0.1 | 0.2      | mA      |
|                                              |                       | Note 5     | -   | 0.1 | 0.2      | mA      |
| Operating Current for $V_{CC}$               | $I_{CC}$              | Note 4     | -   | 1.5 | 2.2      | mA      |
|                                              |                       | Note 5     | -   | 2.5 | 3.5      | mA      |
| Sleep Mode Current for $V_{DD}$ & $V_{DDIO}$ | $I_{DD\&DDIO, SLEEP}$ | -          | -   | -   | 10       | $\mu A$ |
| Sleep Mode Current for $V_{CC}$              | $I_{CC, SLEEP}$       | -          | -   | -   | 10       | $\mu A$ |

Note 4:  $V_{DD} = 2.8V$ ,  $V_{CC} = 9V$ , Frame Rate = 190Hz, Contrast Setting = 0x2D, 50% Display Area Turn on.

Note 5:  $V_{DD} = 2.8V$ ,  $V_{CC} = 9V$ , Frame Rate = 190Hz, Contrast Setting = 0x2D, 100% Display Area Turn on.

## 4. Functional Specification

### 4.1 Commands

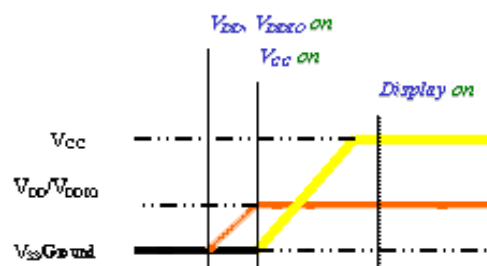
Refer to the Technical Manual for the SSD1305

### 4.2 Power down and Power up Sequence

To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.

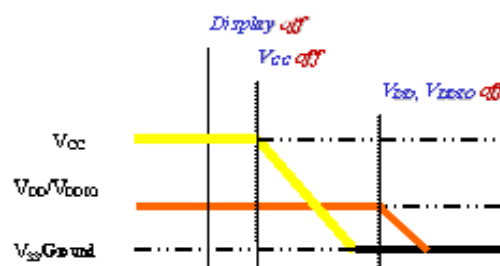
#### 4.2.1 Power up Sequence:

1. Power up  $V_{DD}$  &  $V_{DDIO}$
2. Send Display off command
3. Clear Screen
4. Power up  $V_{CC}$
5. Delay 100ms  
(when  $V_{DD}$  &  $V_{DDIO}$  is stable)
6. Send Display on command



#### 4.2.2 Power down Sequence:

1. Send Display off command
2. Power down  $V_{CC}$
3. Delay 100ms  
(when  $V_{CC}$  is reach 0 and panel is completely discharges)
4. Power down  $V_{DD}$  &  $V_{DDIO}$



### 4.3 Reset Circuit

When RES# input is low, the chip is initialized with the following status:

1. Display is OFF
2. 132x64 Display Mode
3. Normal segment and display data column and row address mapping (SEG0 mapped to column address 00H and COM0 mapped to row address 00H)
4. Shift register data clear in serial interface
5. Display start line is set at display RAM address 0
6. Column address counter is set at 0
7. Normal scan direction of the COM outputs
8. Contrast control register is set at 80H
9. Normal display mode (Equivalent to A4h command)

#### 4.4 Actual Application Example

Command usage and explanation of an actual example

<Initialization Setting>

Set Deactivate Scroll  
(00101101)

Set Pre-charge Period  
(11011001 with XXXXXXXX)

Set Contrast Control Register  
(10000001 with XXXXXXXX)

Set Brightness for Color Banks  
(10000010 with XXXXXXXX)

Set Look Up Table (LUT)  
(10010001 with \*\*XXXXXX, \*\*XXXXXX, \*\*XXXXXX, \*\*XXXXXX)

Set Area Color Mode & Low Power Display Mode  
(11011000 with 00XX0X0X)  
00000101 => 0x05 (Mono & Low Power Save Mode)

Set Segment Re-map  
(1010000X)

Set COM Output Scan Direction  
(1100X000)

Set COM Pins Hardware Configuration  
(11011010 with 00XX0010)  
00010010 => 0x12 (Alternative Mode)

Set Display Start Line  
(01XXXXXX)

Set Display Offset  
(11010011 with \*\*XXXXXX)

Set Multiplex Ratio  
(10101000 with \*\*XXXXXX)

Set Display Clock Divide Ratio / Oscillator Frequency  
(11010101 with XXXXXXXX)

Set DC/DC On/Off  
(10101101 with 1000101X)  
10001010 => 0x8A (Off)

Set VCOMH Deselect Level  
(11011011 with 0XXXXX00)

Set Entire Display On (1010010X)  
10100100 => 0xA4 (Normal)

Set Normal/Inverse Display (1010011X)  
10100110 => 0xA6 (Normal)

Set Display On/Off (1010111X)  
10101111 => 0xAF (Turns On)

<Display Boundary Setting>

Set Memory Addressing Mode  
(00100000 with \*\*\*\*\*XX)

<Page Addressing Mode Setting>

Set Page Start Address for Page Addressing Mode (10110XXX)  
10110000 => 0xB0

Set Lower Column Address for Page Addressing Mode  
(0000XXXX)

Set Higher Column Address for Page Addressing Mode  
(0001XXXX)

<Horizontal or Vertical Addressing Mode Setting>

Set Column Address  
(00100001 with XXXXXXXX, XXXXXXXX)

Set Page Address  
(00100010 with \*\*\*\*\*XX, \*\*\*\*\*XX)

If the noise is accidentally occurred at the displaying window during the operation,  
please reset the display in order to recover the display function.

## 5. Reliability

### 5.1 Contents of Reliability Tests

| Item                                | Conditions                                               | Criteria                                                             |
|-------------------------------------|----------------------------------------------------------|----------------------------------------------------------------------|
| High Temperature Operation          | 70°C, 240 hrs                                            | The brightness should be greater than 50% of the initial brightness. |
| Low Temperature Operation           | -30°C, 240 hrs                                           |                                                                      |
| High Temperature Storage            | 80°C, 240 hrs                                            |                                                                      |
| Low Temperature Storage             | -40°C, 240 hrs                                           |                                                                      |
| High Temperature/Humidity Operation | 60°C, 90% RH, 120 hrs                                    | The operational functions work.                                      |
| Thermal Shock                       | -40°C $\Leftrightarrow$ 85°C, 24 cycles<br>60 mins dwell |                                                                      |

\* No moisture condensation is observed during tests.

### 5.2 Lifetime

End of lifetime is specified as 50% of initial brightness.

An average operating lifetime of more than 10,000 hrs at room temperature is approached by high temperature operations.

### 5.3 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at  $23\pm5^{\circ}\text{C}$ ,  $55\pm15\%$  RH.

## 6. Outgoing Quality Control Specifications

### 6.1 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

|                                                               |                            |
|---------------------------------------------------------------|----------------------------|
| Temperature:                                                  | $23 \pm 5^{\circ}\text{C}$ |
| Humidity:                                                     | $55 \pm 15\% \text{RH}$    |
| Fluorescent Lamp:                                             | 30W                        |
| Distance between the Panel & Lamp:                            | $\geq 50 \text{ cm}$       |
| Distance between the Panel & Eyes of the Inspector:           | $\geq 30 \text{ cm}$       |
| Finger glove (or finger cover) must be worn by the inspector. |                            |
| Inspection table or jig must be anti-electrostatic.           |                            |

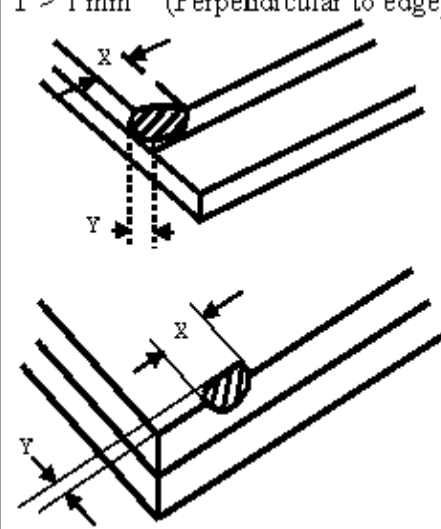
### 6.2 Sampling Plan

Level II, Normal Inspection, Single Sampling, MIL-STD-105E

### 6.3 Criteria & Acceptable Quality Level

| Partition | AQL  | Definition                              |
|-----------|------|-----------------------------------------|
| Major     | 0.65 | Defects in Pattern Check (Display On)   |
| Minor     | 1.0  | Defects in Cosmetic Check (Display Off) |

#### 6.3.1 Cosmetic Check (Display Off) in Non-Active Area

| Check Item                | Classification | Criteria                                                                                                                                                                   |
|---------------------------|----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Panel<br>General Chipping | Minor          | $X > 6 \text{ mm}$ (Along with Edge)<br>$Y > 1 \text{ mm}$ (Perpendicular to edge)<br> |

Date : Oct. 02, 2007

TECHNICAL SPECIFICATION

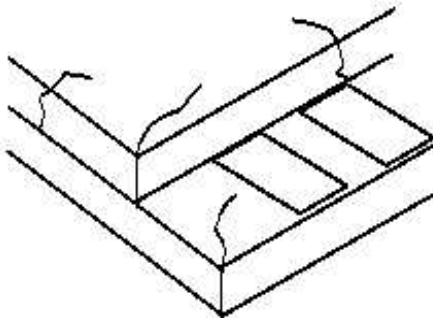
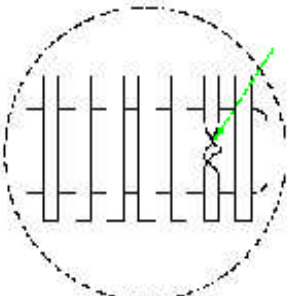
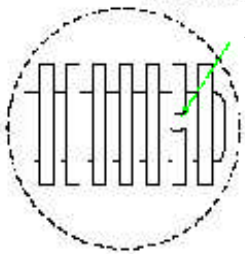
**HYES**

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### 6.3.1 Cosmetic Check (Display Off) in Non-Active Area (Continued)

| Check Item                        | Classification | Criteria                                                                                                                     |
|-----------------------------------|----------------|------------------------------------------------------------------------------------------------------------------------------|
| Panel Crack                       | Minor          | Any crack is not allowable.<br>            |
| Copper Exposed (Even Pin or Film) | Minor          | Not Allowable by Naked Eye Inspection<br> |
| Film or Trace Damage              | Minor          |                                           |
| Terminal Lead Twist               | Minor          | Not Allowable<br> B, Twisted Lead        |
| Terminal Lead Broken              | Minor          | Not Allowable<br> A, Broken Lead          |
| Terminal Lead Prober Mark         | Acceptable     | Ok                                                                                                                           |

Date : Oct. 02, 2007

TECHNICAL SPECIFICATION

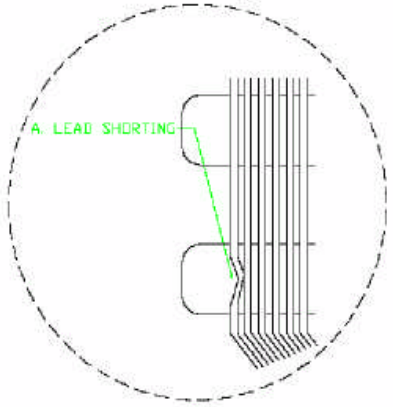
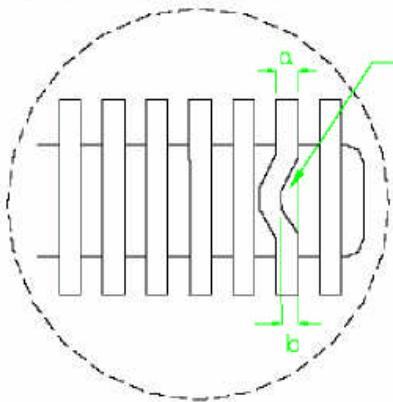
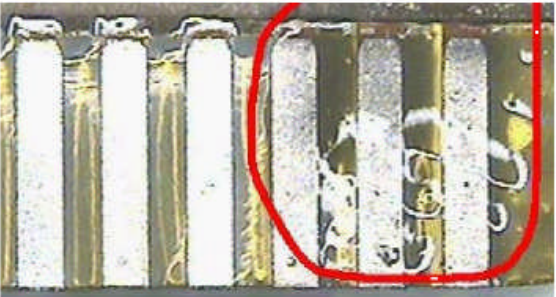
**HYES**

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### 6.3.1 Cosmetic Check (Display Off) in Non-Active Area (Continued)

| Check Item                                                             | Classification | Criteria                                                                                                                                             |
|------------------------------------------------------------------------|----------------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| Terminal Lead Bent<br>(Not Twist or Broken)                            | Minor          | <p>NG if any bent lead cause lead shorting.</p>                    |
|                                                                        | Minor          | <p>NG for horizontally bent lead more than 50% of its width.</p>  |
| Glue or Contamination<br>on Pin<br>(Couldn't Be Removed<br>by Alcohol) | Minor          |                                                                  |
| Ink Marking on Back<br>Side of panel<br>(Exclude on Film)              | Acceptable     | Ignore for Any                                                                                                                                       |

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TECHNICAL SPECIFICATION

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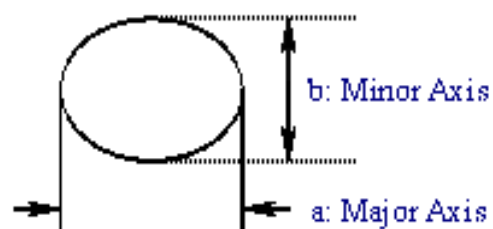
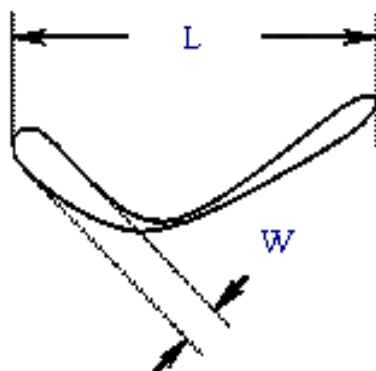
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### 6.3.2 Cosmetic Check (Display Off) in Active Area

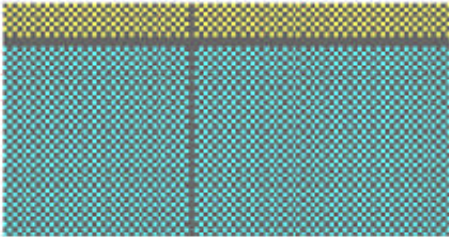
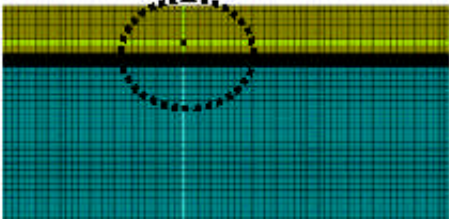
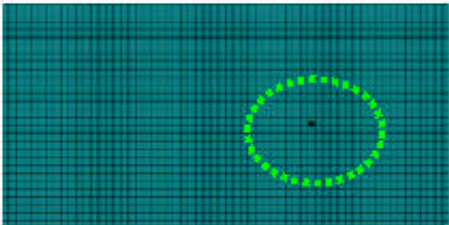
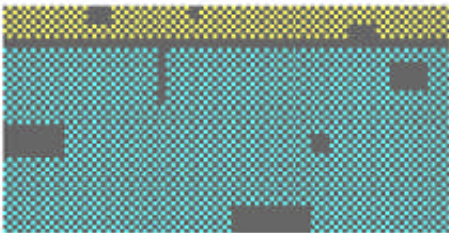
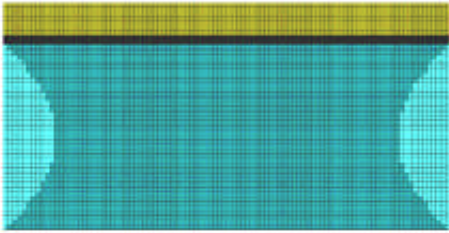
| Check Item                                                     | Classification | Criteria                                                                             |
|----------------------------------------------------------------|----------------|--------------------------------------------------------------------------------------|
| Any Dirt & Scratch on Protective Film                          | Acceptable     | Ignore for Any                                                                       |
| Scratches, Fiber, Line-Shape Defect<br>(On Glass Display Side) | Minor          | $W \leq 0.1$ Ignore<br>$W > 0.1$ &<br>$L \leq 2$ $n \leq 1$<br>$L > 2$ $n = 0$       |
| Dirt, Spot-Shape Defect<br>(On Glass Display Side)             | Minor          | $\Phi \leq 0.1$ Ignore<br>$0.1 < \Phi \leq 0.25$ $n \leq 1$<br>$0.25 < \Phi$ $n = 0$ |
| Bubbles, or Dent<br>(On Polarizer)                             | Minor          | $\Phi \leq 0.5$ $n = 1$<br>$0.5 < \Phi$ $n = 0$                                      |
| Fingerprint, Flow Mark<br>(On Glass Display Side)              | Minor          | Not Allowable                                                                        |

\* Protective film should not be tear off when cosmetic check.

\*\* Definition of W & L &  $\Phi$  (Unit: mm):  $\Phi = (a + b) / 2$



### 6.3.3 Pattern Check (Display On) in Active Area

| Check Item    | Classification | Criteria                                                                             |
|---------------|----------------|--------------------------------------------------------------------------------------|
| No Display    | Major          |    |
| Flicker       | Major          | Not Allowable                                                                        |
| Missing Line  | Major          |    |
| Pixel Short   | Major          |   |
| Darker Pixel  | Major          |  |
| Wrong Display | Major          |  |
| Un-uniform    | Major          |  |

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TECHNICAL SPECIFICATION

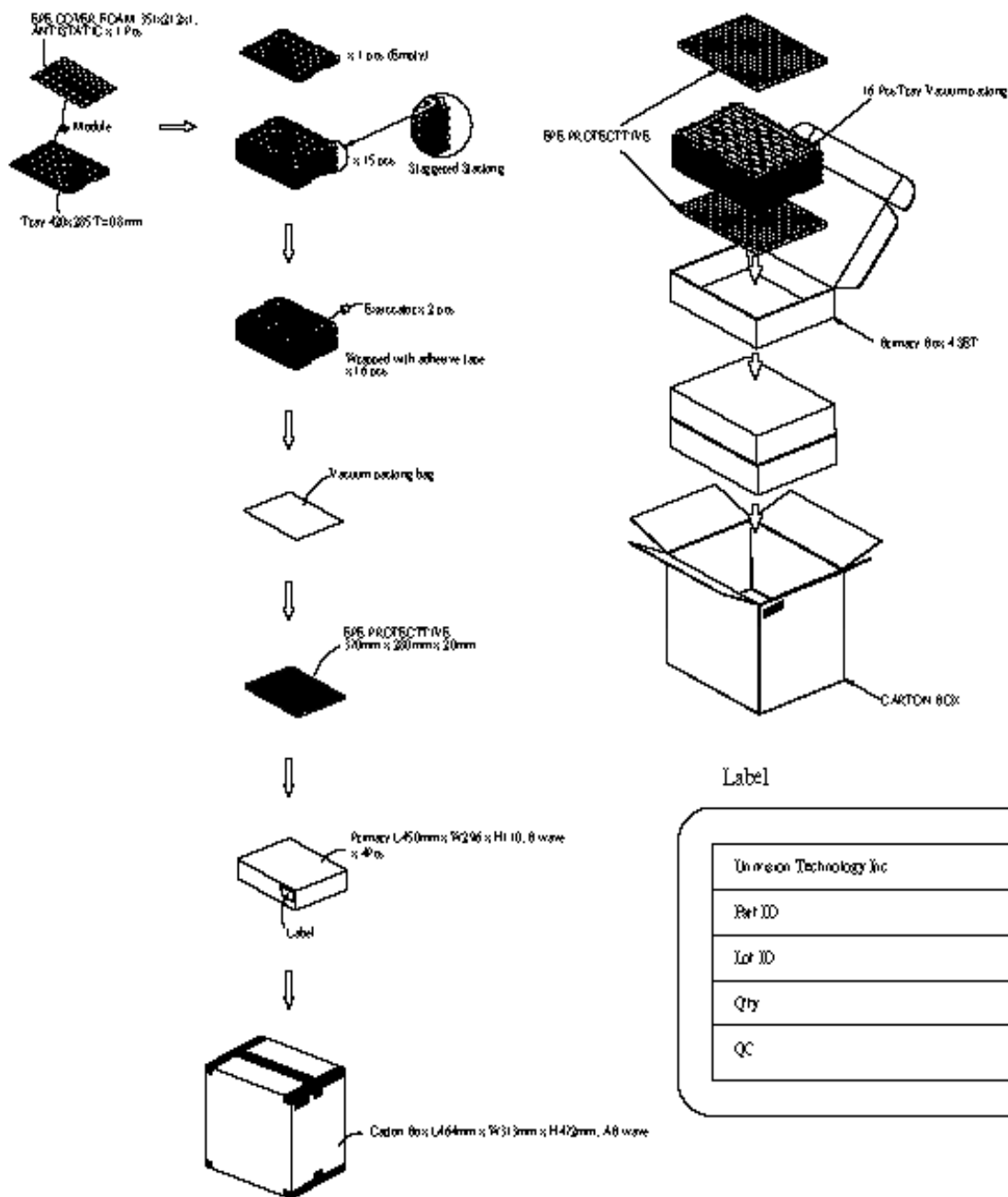
**HYES**

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## 7. Package Specifications



Label

|                      |
|----------------------|
| Union Technology Inc |
| Part ID              |
| Lot ID               |
| Qty                  |
| QC                   |

Date : Oct. 02, 2007

TECHNICAL SPECIFICATION

**HYES**

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## **8. Precautions When Using These OEL Display Modules**

### **8.1 Handling Precautions**

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalentNever try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.  
Also, pay attention that the following liquid and solvent may spoil the polarizer:
  - \* Water
  - \* Ketone
  - \* Aromatic Solvents
- 6) When installing the OEL display module, be careful not to apply twisting stress or deflection stress to the OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.
- 7) Do not apply stress to the LSI chips and the surrounding molded sections.
- 8) Do not disassemble nor modify the OEL display module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handling OEL display modules to prevent occurrence of element breakage accidents by static electricity.
  - \* Be sure to make human body grounding when handling OEL display modules.
  - \* Be sure to ground tools to use or assembly such as soldering irons.
  - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
  - \* Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be

corroded and be careful to avoid the above.

## 8.2 Storage Precautions

- 1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

- 2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

## 8.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OEL display module, fasten the external plastic housing section.
- 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1305  
\* Connection (contact) to any other potential than the above may lead to rupture of the IC.

## 8.4 Precautions when disposing of the OEL display modules

- 1) Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

## 8.5 Other Precautions

- 1) When an OEL display module is operated for a long of time with fixed pattern

may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

- 2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.

- \* Pins and electrodes

- \* Pattern layouts such as the COF

- 3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.

- \* Design the product and installation method so that the OEL driver may be shielded from light in actual usage.

- \* Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.

- 4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.

- 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.